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TLE7250G

High Speed CAN Transceiver

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Data Sheet

Rev. 1.1, 2013-07-22

Automotive Power



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High Speed CAN Transceiver

TLE7250G





1 Overview

Features

- Fully compliant with ISO 11898-2
- Wide common mode range for electromagnetic immunity (EMI)
- Very low electromagnetic emission (EME)
- Excellent ESD immunity
- Extended supply range at V_{CC}
- CAN short-circuit proof to ground, battery and V_{CC}
- TxD time-out function
- Low CAN bus leakage current in power-down state
- Overtemperature protection
- Protected against automotive transients
- CAN data transmission rate up to 1 Mbps
- Green Product (RoHS-compliant)
- AEC Qualified



PG-DSO-8

Description

The TLE7250G is a transceiver designed for High Speed CAN networks in automotive and industrial applications. As an interface between the physical bus layer and the CAN protocol controller, the TLE7250G drives the signals to the bus and protects the microcontroller against interferences generated within the network. Based on the high symmetry of the CANH and CANL signals, the TLE7250G provides a very low level of electromagnetic emission (EME) within a wide frequency range. The TLE7250G is integrated in a RoHS compliant PG-DSO-8 package and fulfills or exceeds the requirements of ISO 11898-2.

As a successor to the first generation of HS CAN transceivers, the pin assignment and function of the TLE7250G is fully compatible with its predecessor model, the TLE6250G. The TLE7250G is optimized to provide an excellent passive behavior in the power-down state. This feature makes the TLE7250G extremely suitable for mixed supply CAN networks.

Based on the Infineon Smart Power Technology SPT, the TLE7250G provides excellent ESD immunity together with a very high electromagnetic immunity (EMI). The Infineon Smart Power Technology SPT allows bipolar and CMOS control circuitry in accordance with DMOS power devices to exist on the same monolithic circuit. The TLE7250G and the Infineon SPT technology are AEC qualified and tailored to withstand the harsh conditions of the Automotive Environment.

Three different operating modes, additional fail-safe features like TxD time-out and the optimized output slew rates on the CANH and CANL signals make the TLE7250G the ideal choice for large CAN networks with high data transmission rates.

Туре	Package	Marking
TLE7250G	PG-DSO-8	7250G

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Block Diagram

2 Block Diagram

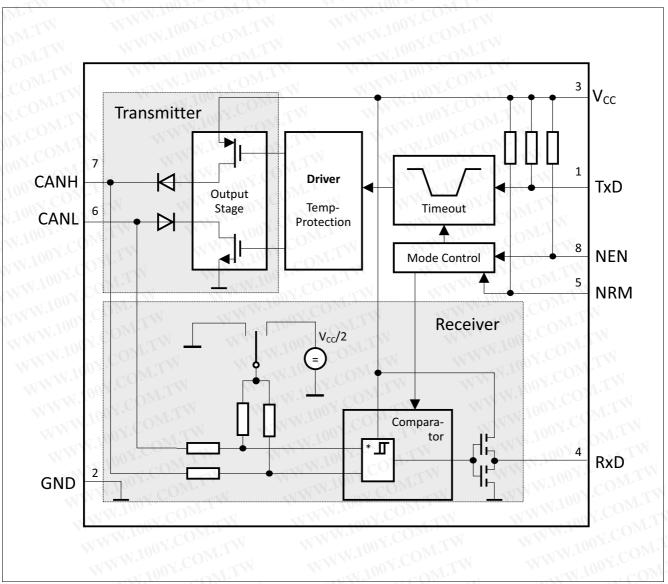


Figure 1 Block diagram

Note: In comparison with the TLE6250G, the pin 8 (INH) was renamed as NEN, but the function remains unchanged. NEN stands for NotENable. The name of pin 5 has been changed from RM (TLE6250G) to NRM on the TLE7250G. The function of pin 5 remains unchanged.



Pin Configuration

Pin Configuration 3

Pin Assignment 3.1

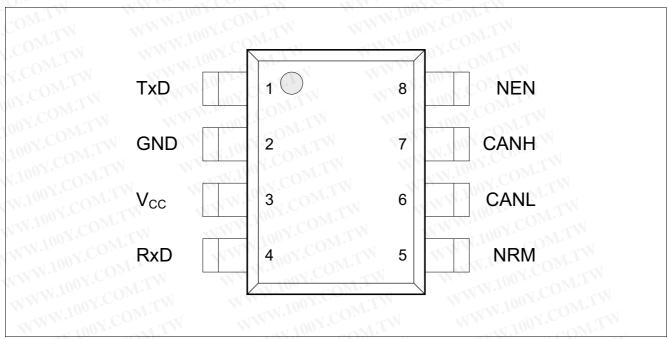


Figure 2 Pin configuration

3.2 **Pin Definitions and Functions**

Pin Definition and Functions Table 1

Pin	Symbol	Function
1	TxD TxD	Transmit Data Input; internal pull-up to $V_{\rm CC}$, "low" for "dominant" state.
2	GND	Ground WWW.
3	V _{CC}	Transceiver Supply Voltage; 100 nF decoupling capacitor to GND required.
4	RxD	Receive Data Output; "low" in "dominant" state.
5	NRM	Not Receive-only Mode Input ¹⁾ ; control input for selecting receive-only mode, internal pull-up, to $V_{\rm CC}$, "low" for receive-only mode.
6	CANL	CAN Bus Low Level I/O; "low" in "dominant" state.
7	CANH	CAN Bus High Level I/O; "high" in "dominant" state.
8	NEN	Not Enable Input $^{1)}$; internal pull-up to $V_{\rm CC}$, "low" to select normal-operation mode or receive-only mode.

The designation of pin 8 and pin 5 is different in the TLE7250G and its predecessor, the TLE6250G. The function of pin 8 WWW.100Y.COM.T and pin 5 remains the same.



4 Functional Description

CAN is a serial bus system that connects microcontrollers, sensors and actuators for real-time control applications. The use of the <u>C</u>ontrol <u>A</u>rea <u>N</u>etwork (abbreviated CAN) within road vehicles is described by the international standard ISO 11898. According to the 7-layer OSI reference model, the physical layer of a CAN bus system specifies the data transmission from one CAN node to all other available CAN nodes within the network. The physical layer specification of a CAN bus system includes all electrical and mechanical specifications of a CAN network. The CAN transceiver is part of the physical layer specification. Several different physical layer definitions of CAN networks have been developed in recent years. The TLE7250G is a High Speed CAN transceiver without a dedicated wake-up function. High Speed CAN transceivers without a wake-up function are defined by the international standard ISO 11898-2.

4.1 High Speed CAN Physical Layer

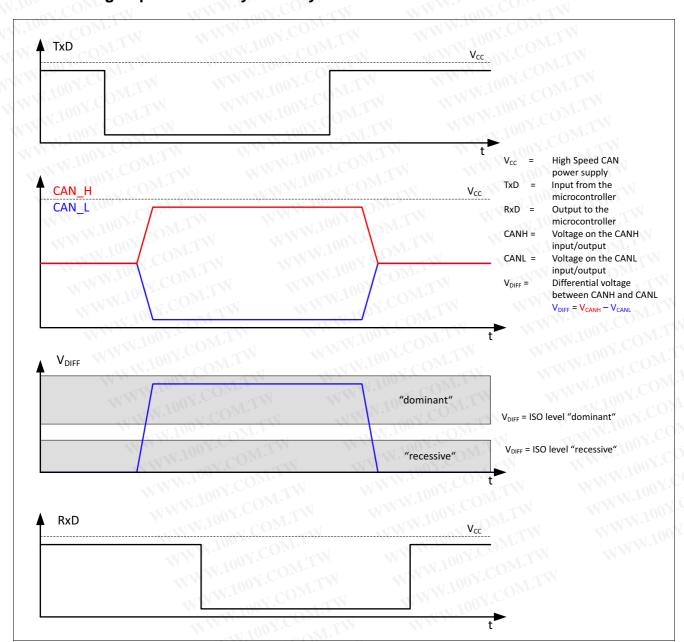


Figure 3 High Speed CAN bus signals and logic signals



The TLE7250G is a High Speed CAN transceiver, operating as an interface between the CAN controller and the physical bus medium. An HS CAN network is a two-wire, differential network, which allows data transmission rates up to 1 Mbps. The characteristics of an HS CAN network are the two signal states on the CAN bus: "dominant" and "recessive" (see Figure 3).

The CANH and CANL pins are the interface to the CAN bus and both pins operate as an input and output. The RxD and TxD pins are the interface to the microcontroller. The TxD pin is the serial data input from the CAN controller, and the RxD pin is the serial data output to the CAN controller. As shown in **Figure 1**, the HS CAN transceiver TLE7250G includes a receiver and a transmitter unit, allowing the transceiver to send data to the bus medium and monitor the data from the bus medium at the same time. The HS CAN transceiver TLE7250G converts the serial data stream which is available on the transmit data input TxD, into a differential output signal on the CAN bus, provided by the CANH and CANL pins. The receiver stage of the TLE7250G monitors the data on the CAN bus and converts them to a serial, single-ended signal on the RxD output pin. A logical "low" signal on the TxD pin creates a "dominant" signal on the CAN bus, followed by a logical "low" signal on the RxD pin (see **Figure 3**). The feature of broadcasting data to the CAN bus and listening to the data traffic on the CAN bus simultaneously is essential to support the bit-to-bit arbitration within CAN networks.

The voltage levels for HS CAN transceivers are defined by the ISO 11898-2 and the ISO 11898-5 standards. Whether a data bit is "dominant" or "recessive" depends on the voltage difference between the CANH and CANL pins:

 $V_{\text{DIFF}} = V_{\text{CANH}} - V_{\text{CANL}}$

In comparison with other differential network protocols, the differential signal on a CAN network can only be larger than or equal to 0 V. To transmit a "dominant" signal to the CAN bus, the differential signal $V_{\rm DIFF}$ is larger than or equal to 1.5 V. To receive a "recessive" signal from the CAN bus, the differential $V_{\rm DIFF}$ is smaller than or equal to 0.5 V.

"Partially-supplied" High Speed CAN networks are those where the CAN bus nodes of one common network have different power supply conditions. Some nodes are connected to the common power supply, while other nodes are disconnected from the power supply and in power-down state. Regardless of whether the CAN bus subscriber is supplied or not, each subscriber connected to the common bus media must not interfere with the communication. The TLE7250G is designed to support "partially-supplied" networks. In power-down state, the receiver input resistors are switched off and the transceiver input has a high resistance.



4.2 Modes of Operation

Three different modes of operation are available on the TLE7250G. Each mode has specific characteristics in terms of quiescent current or data transmission. NEN and NRM are used as the digital input pins for mode selection. Figure 4 illustrates the different mode changes depending on the status of the NEN and NRM pins. After supplying $V_{\rm CC}$ to the HS CAN transceiver, the TLE7250G starts in stand-by mode. The internal pull-up resistors set the TLE7250G to stand-by mode by default. If the microcontroller is up and running, the TLE7250G can switch to any mode of operation within the time period for mode change $t_{\rm Mode}$.

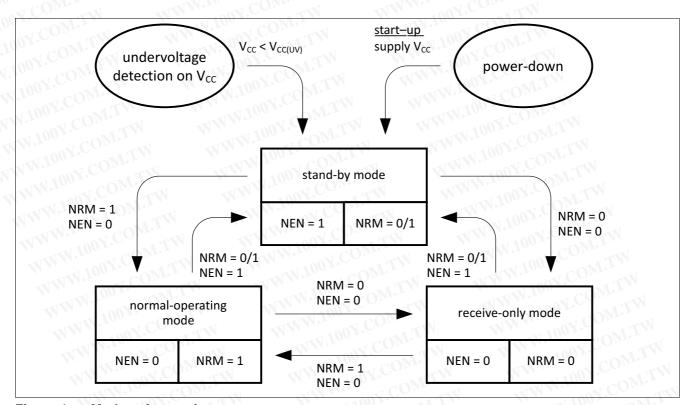


Figure 4 Modes of operation

The TLE7250G has 3 major modes of operation:

- Stand-by mode
- Normal-operating mode
- · Receive-only mode

Table 2 Modes of Operation

Mode	NRM	NEN	Bus Bias	Comments
Normal-operating mode	"high"	"low"	$V_{\rm CC}/2$	The transmitter is active. The receiver is active.
Stand-by	"low" or "high"	"high"	GND	The transmitter is disabled. The receiver is disabled.
Receive-only	"low"	"low"	$V_{\rm CC}/2$	The transmitter is disabled. The receiver is active.
$\overline{V_{\mathrm{CC}}}$ off	"low" or "high"	"low" or "high"	floating	The transmitter is disabled. The receiver is disabled.



4.3 Normal-operating Mode

In the normal-operating mode, the HS CAN transceiver TLE7250G sends the serial data stream on the TxD pin to the CAN bus. The data on the CAN bus is displayed at the RxD pin simultaneously. In the normal-operating mode, all functions of the TLE7250G are active:

- The transmitter is active and drives data from the TxD to the CAN bus.
- The receiver is active and provides the data from the CAN bus to the RxD pin.
- The bus biasing is set to $V_{\rm CC}/2$.
- The undervoltage monitoring at the power supply V_{CC} is active.

To enter the normal-operating mode, set the pin NRM to logical "high" and the pin NEN to logical "low" (see Table 2 or Figure 4). Both pins, the NEN pin and the NRM pin have internal pull-up resistors to the power-supply $V_{\rm CC}$.

4.4 Receive-only Mode

The receive-only mode can be used to test the connection of the bus medium. The TLE7250G can still receive data form the bus, but the transmitter is disabled and hence, no data can be sent to the CAN bus. All other functions are active:

- The transmitter is disabled and data, which is available on the TxD pin, is blocked and not sent to the CAN bus.
- The receiver is active and provides the data from the CAN bus to the RxD output pin.
- The bus biasing is set to $V_{\rm CC}/2$.
- The undervoltage monitoring on the power supply $V_{\rm CC}$ is active.

To enter the receive-only mode, set the pin NRM to logical "low" and the pin NEN to logical "low" (see **Table 2** or **Figure 4**). In case the receive-only mode is not used, the NRM pin can be left open.

4.5 Stand-by Mode

The stand-by mode is an idle mode of the TLE7250G with optimized power consumption. In the stand-by mode, the TLE7250G can not send or receive any data. The transmitter and the receiver are disabled. Both CAN bus pins, CANH and CANL are connected to GND via the input resistors.

- · The transmitter is disabled.
- The receiver is disabled.
- The input resistors of the receiver unit are connected to GND.
- The undervoltage monitoring at the power supply $V_{\rm CC}$ is active.

To enter the stand-by mode, set the pin NEN to logical "high", the logical state of the NRM pin has no influence on the mode selection (see **Table 2** or **Figure 4**). Both pins, the NEN and the NRM pin have an internal pull-up resistor to the power-supply $V_{\rm CC}$. If the stand-by mode is not used in the application, the NEN pin needs to be connected to GND.

In case the NRM pin is set to logical "low" in the stand-by mode, the internal pull-up resistor causes an additional quiescent current from $V_{\rm CC}$ to GND, therefore it is recommended to set the NRM pin to logical "high" in stand-by mode or leave the pin open, if the receive-only mode is not used in the application.

4.6 Power-down state

The power-down state means that the TLE7250G is not supplied. In power-down state, the differential input resistors of the receiver stage are switched off. The CANH and CANL bus interface of the TLE7250G acts as high-impedance input with a very small leakage current. The high-ohmic input does not influence the "recessive" level of the CAN network and allows an optimized EME performance of the entire CAN network.



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Fail-safe Functions

5 Fail-safe Functions

5.1 Short-circuit Protection

The CANH and CANL bus outputs are short-circuit proof, either against GND or a positive supply voltage. A current limiting circuit protects the transceiver against damage. If the device heats up due to a continuous short on the CANH or CANL, the internal overtemperature protection switches off the transmitter.

5.2 Unconnected Logic Pins

All logic input pins have an internal pull-up resistor to $V_{\rm CC}$. In case the $V_{\rm CC}$ supply is activated and the logical pins are open or floating, the TLE7250G enters into the stand-by mode by default. In stand-by mode, the transmitter of the TLE7250G is disabled, the bus bias is connected to GND and the HS CAN TLE7250G transceiver does not influence the data on the CAN bus.

5.3 TxD Time-out Function

The TxD time-out feature protects the CAN bus against permanent blocking in case the logical signal on the TxD pin is continuously "low". A continuous "low" signal on the TxD pin can have its root cause in a locked-up microcontroller or in a short on the printed circuit board for example. In normal-operating mode, a logical "low" signal on the TxD pin for the time $t > t_{TxD}$ enables the TxD time-out and the TLE7250G disables the transmitter (see **Figure 5**). The receiver is still active and the data on the bus continues to be monitored by the RxD output pin.

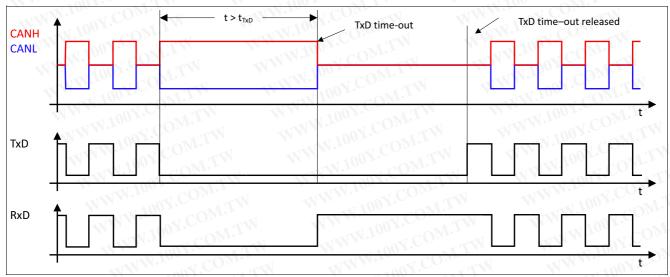


Figure 5 TxD Time-out function

Figure 5 illustrates how the transmitter is deactivated and activated again. A permanent "low" signal on the TxD input pin activates the TxD time-out function and deactivates the transmitter. To release the transmitter after a TxD time-out event, the TLE7250G requires a signal change on the TxD input pin from logical "low" to logical "high".

5.4 Undervoltage Detection

The HS CAN Transceiver TLE7250G is provided with undervoltage detection at the power supply $V_{\rm CC}$. In case of an undervoltage event on $V_{\rm CC}$, the undervoltage detection changes the operating mode of TLE7250G to the standby mode, regardless of the logical signal on the NEN and NRM pins (see **Figure 6**). If the transceiver TLE7250G recovers from the undervoltage condition, the operating mode is restored to the programmed mode by the logical pins NEN and NRM.



Fail-safe Functions

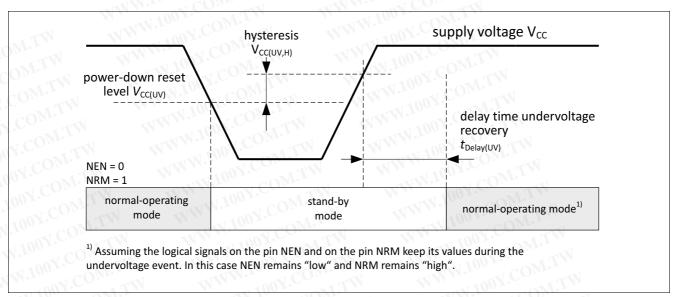


Figure 6 Undervoltage detection on V_{CC}

5.5 Overtemperature Protection

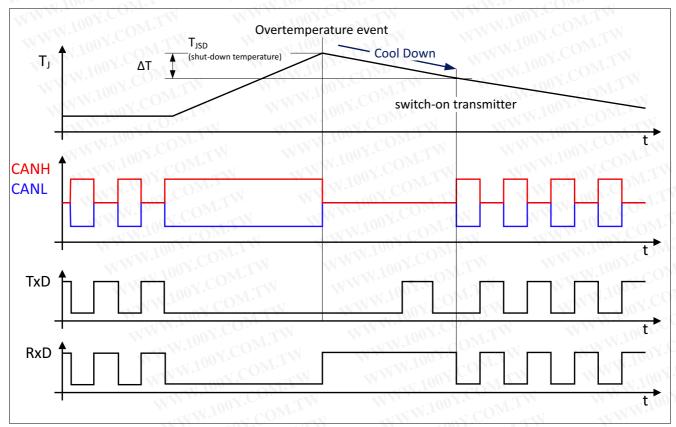


Figure 7 Overtemperature protection

The TLE7250G has an integrated overtemperature detection circuit to protect the device against thermal overstress of the transmitter. In case of an overtemperature condition, the temperature sensor will disable the transmitter (see **Figure 1**). After the device cools down, the transmitter is activated again (see **Figure 7**). A hysteresis is implemented within the temperature sensor.



General Product Characteristics

6 General Product Characteristics

6.1 Absolute Maximum Ratings

Table 3 Absolute Maximum Ratings of Voltage, Current and Temperatures¹⁾

All voltages with respect to ground; positive current flowing into the pin; (unless otherwise specified)

Pos.	Parameter	Symbol	Limit Va	lues	Unit	Remarks	
	MIN WWW.	WWW. TOA. CO.		Max.	1001.00	ON.TW	
Voltag	e TW WWW	100 Y. CON	TW	MM	100Y.C	OM.TW	
6.1.1	Supply voltage	$V_{\sf CC}$	-0.3	6.0	VOY	TI.TW	
6.1.2	CANH DC voltage against GND	V_{CANH}	-40	40	V Vooy	COM.TW	
6.1.3	CANL DC voltage against GND	V_{CANL}	-40	40	W.V.100	X CON.TW	
6.1.4	Differential voltage between CANH and CANL	$V_{CAN\;diff}$	-40	40	V 1.10	ODY.COM.TW	
6.1.5	Logic voltage logic input pins NEN, NRM, TxD	V_{Max_In}	-0.3	6.0	V	.1187.COM.TW	
6.1.6	Logic voltage at logic output RxD	V_{Max_Out}	-0.3	$V_{\rm CC}$	V	W.100Y.COM.TW	
Tempe	erature	W W	1.1007.	OM.TW	W	M.1001. COM.I.	
6.1.7	Junction temperature	$T_{\rm j}$	-40	150	°C	W.1001.	
6.1.8	Storage temperature	T_{S}	- 55	150	°C	- TI 100X. CON IN	
ESD In	nmunity	WV	100	I.Com.T	1	WW. 100Y. COM.TW	
6.1.9	ESD immunity at CANH, CANL against GND	$V_{\rm ESD_HBM_CAN}$	-8	X 8 COM.T	kV	HBM (100pF via 1.5 kΩ) ²⁾	
6.1.10	ESD immunity at all other pins	$V_{ESD_HBM_AII}$	-2	2 CON	kV	HBM (100pF via 1.5 k Ω) ²⁾	
6.1.11	ESD immunity to GND (all pins)	V_{ESD_CDM}	-750	750	V V	CDM ³⁾	

¹⁾ Not subject to production test, specified by design

Note: Within the functional range the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the associated electrical characteristics table.

²⁾ ESD susceptibility Human Body Model "HBM" according to ANSI/ESDA/JEDEC JS-001

³⁾ ESD susceptibility, Charged Device Model "CDM" according to EIA/JESD22-C101 or ESDA STM5.3.1



General Product Characteristics

6.2 **Functional Range**

Table 4 **Operating Range**

6.2	Functional Range					
Table 4	Operating Range					
Pos.	Parameter	Symbol	Lir	nit Values	Unit	Conditions
COMT	M. M. 100 J.	M.	Min.	Max.		
Supply	Voltage	$O_{M \cdot L_{A}}$	NA TANA	N.100 × CO	W. I	
6.2.1	Transceiver supply voltage	V_{CC}	4.5	5.5	V	_
Therma	al Parameter	COMIN		M.1007.	OWIT	1
6.2.2	Junction temperature	T_{J}	-40	150	°C	1)

Not subject to production test, specified by design

Note: Within the functional range the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the associated electrical characteristics table.

Thermal Characteristics

Note: This thermal data was generated in accordance with JEDEC JESD51 standards. For more information, please visit www.jedec.org.

Table 5 Thermal Resistance¹⁾

Pos.	Parameter	Symbol	Limit V	alues	Unit	Remarks	
	TW.100Y.COM.TW	N. A.	Min.	Typ.	Max.	1111	M TOO I. COM: I.
Therm	nal Resistance	W.	-11N.100	COM	J. A.	N. T.	W.100 T. COM.T
6.3.1	Junction to ambient ¹⁾	R_{thJA}	1 - 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	130	1. 7	K/W	2)
Therm	nal Shut-down Junction	Temperatur	e	00 X	WI.W	1/1	W.100Y.COM.TW
6.3.2	Thermal shut-down temperature.	T_{JSD}	150	175	200	°C	MM.100X.COW.T.
6.3.3	Thermal shut-down hysteresis	ΔΤ	-WW	10	CO_{MT}	K	A-MM.TOOA.COW.

Not subject to production test, specified by design

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The $R_{th,JA}$ value specified, is according to Jedec JESD51-2,-7 at natural convection on the FR4 2s2p board; The product 2) (TLE7250G) was simulated on a 76.2 x 114.3 x 1.5 mm board with 2 inner copper layers (2 x 70 μm Cu, 2 x 35 μm Cu).



7 **Electrical Characteristics**

Functional Device Characteristics

Table 6 **Electrical Characteristics**

4.5 V < $V_{\rm CC}$ < 5.5 V; $R_{\rm L}$ = 60 Ω ; -40 °C < $T_{\rm j}$ < +150 °C; all voltages with respect to ground; positive current flowing into the pin; unless otherwise specified.

Pos.	Parameter	Symbol	Limit	Values	MIN.10	Unit	Remarks	
	WWW.	OX.COM	Min.	Тур.	Max.	001.	ONITW	
Curre	nt Consumption	OON.CO	(TW	N N	N VV	1007	CON.TW	
7.1.1	Current consumption	$I_{\rm CC}$	TIV	2	6	mA	"recessive" state; $V_{TXD} = V_{CC}$	
7.1.2	Current consumption	$I_{\rm CC}$	OM.T	35	60	mA	"dominant" state; V_{TXD} = "low"	
7.1.3	Current consumption	$I_{\rm CC(ROM)}$	COM	2	6	mA	receive-only mode; NEN = NRM = "low"	
7.1.4	Current consumption	$I_{\text{CC(STB)}}$	Y.COD	7	15	μА	stand-by mode; TxD = NRM = NEN = "high	
Suppl	y Resets	MW.IO	V.CO	Mr.	N .	WW	W. rac CON. TW	
7.1.5	$V_{ m CC}$ undervoltage monitor	$V_{CC(UV)}$	1.3	3.2	4.3	V	EN. TOOK. COM.	
7.1.6	V_{CC} undervoltage monitor hysteresis	$V_{\mathrm{CC}(UV,H)}$	100 X.	400		mV	N.100Y.COM.TW	
7.1.7	$V_{\rm CC}$ undervoltage delay time	t _{Delay(UV)}	1-100×	- OM	50	μS	1) (see Figure 6)	
Recei	ver Output: RxD	MW	100	A CO.	I.TW		MM MIOON CONTLA	
7.1.8	"High" level output current	$I_{RD,H}$	M.10	1-4 CC	-2	mA	$\begin{aligned} V_{\rm RxD} &= V_{\rm CC} - 0.4 \text{ V}, \\ V_{\rm DIFF} &< 0.5 \text{ V} \end{aligned}$	
7.1.9	"Low" level output current	$I_{RD,L}$	2	40Y.C	O_{N} .	mA	$V_{RXD} = 0.4 V,$ $V_{DIFF} > 0.9 V$	
Trans	mission Input: TxD		W T	N.100 x.	COM	IV	M. 100 . CO.	
7.1.10	"High" level input voltage threshold	$V_{TD,H}$	MM	$0.5 imes V_{ extsf{CC}}$	$V_{\rm CC}$	V	"recessive" state	
7.1.11	"Low" level input voltage threshold	$V_{TD,L}$	$0.3 imes V_{ m CC}$	$0.4 imes V_{ m CC}$	ON.CC	V	"dominant" state	
7.1.12	TxD pull-up resistance	R_{TD}	10	25	50	kΩ	WWW.roo	
7.1.13	TxD input hysteresis	$V_{HYS(TxD)}$	-	800	100	mV	1)	
7.1.14	TxD permanent "dominant" disable time	t_{TXD}	0.3	WWY	1.0	ms	VITW WWW.10	
Not E	nable Input NEN	T.M.T		MAN	111.100	N.O.	M.TW WW.	
7.1.15	"High" level input voltage threshold	$V_{NEN,H}$	LM D	$0.5 imes V_{ m CC}$	$0.7 imes V_{ m CC}$	V	stand-by mode	
7.1.16	"Low" level input voltage threshold	$V_{NEN,L}$	$0.3 imes V_{ m CC}$	$0.4 imes V_{ m CC}$	AMM.	You	normal-operating mode	
	_41 11 1	D	10	25	50	kΩ	_	
7.1.17	NEN pull-up resistance	R_{NEN}						



Table 6 Electrical Characteristics (cont'd)

 $4.5~\rm V < V_{CC} < 5.5~\rm V$; $R_L = 60~\Omega$; $-40~\rm ^{\circ}C < T_j < +150~\rm ^{\circ}C$; all voltages with respect to ground; positive current flowing into the pin; unless otherwise specified.

Pos.	Parameter	Symbol	Limit	Values		Unit	Remarks	
	LA MANA 100 3.	$O_{M',I}$	Min.	Тур.	Max.	CO_{M}	, I '	
Recei	ve-only Input NRM	COMIT	×1	-1111	M.Ing.	a CO	VI. I	
7.1.19	"High" level input voltage threshold	$V_{NRM,H}$	N	$0.5 imes V_{ m CC}$	$0.7 imes V_{ ext{CC}}$	V.cc	normal-operating mode	
7.1.20	"Low" level input voltage threshold	$V_{NRM,L}$	$0.3 imes V_{ m CC}$	$0.4 imes V_{ m CC}$	MM.7	V.	receive-only mode	
7.1.21	NRM pull-up resistance	R _{NRM}	10	25	50	kΩ	CONTRACTOR	
7.1.22	NRM input hysteresis	$V_{NRM(Hys)}$	MF.	200	JWV	mV	1)	
Bus R	eceiver	Ton C	DMT	N	WIX	W.In.	ON COMP.	
7.1.23	Differential receiver threshold "dominant"	$V_{DIFF,(D)}$	PW:	0.75	0.9	V	ON. COM. TW	
7.1.24	Differential receiver threshold "recessive"	$V_{DIFF,(R)}$	0.5	0.65	- 1	NW	100X.COM.TW	
7.1.25	Differential receiver input range "dominant"	$V_{ m diff,rdN}$	0.9	NT.TW	5.0	V	N.100Y.COM.TW	
7.1.26	Differential receiver input range "recessive"	$V_{diff,drN}$	-1.0		0.5	V	1) V. JOOY. COM. TW	
7.1.27	Common mode range	CMR	-12	-M.	12	V	$V_{\rm CC} = 5 \text{ V}$	
7.1.28	Differential receiver hysteresis	$V_{\rm diff,hys}$	7007	100	EN	mV	1)	
7.1.29	CANH, CANL input resistance	$R_{\rm i}$	10	20	30	kΩ	"recessive" state	
7.1.30	Differential input resistance	R_{diff}	20	40	60	kΩ	"recessive" state	
7.1.31	Input resistance deviation between CANH and CANL	$\Delta R_{\rm i}$	-3	Oak C	3	%	1) "recessive" state	
7.1.32	Input capacitance CANH, CANL versus GND	C_{IN}	TWW	20	40	pF	¹⁾ $V_{TXD} = V_{CC}$	
7.1.33	Differential input capacitance	C_{InDiff}	M M,	10	20	pF	1) $V_{TXD} = V_{CC}$	
Bus T	ransmitter	TW	MM	100	Y.CO	WII	WW. 1007.00	
7.1.34	CANL/CANH "recessive" output voltage	V _{CANL/H}	2.0	2.5	3.0	V	$\begin{aligned} V_{\text{TXD}} &= V_{\text{CC}}, \\ \text{no load} \end{aligned}$	
7.1.35	CANH, CANL "recessive" output voltage difference	V_{diff}	-500	MANN.	50	mV	$V_{\mathrm{TXD}} = V_{\mathrm{CC}},$ no load	
7.1.36	CANL "dominant" output voltage	V_{CANL}	0.5	MM	2.25	Yon	$4,75 \ \forall \leq V_{\rm CC} \leq 5.25 \ \forall,$ $V_{\rm TxD} = \text{``low''},$ $50 \ \Omega < R_L < 65 \ \Omega$	
7.1.37	CANH "dominant" output voltage	V _{CANH}	2.75	- 11	4.5	V.C	$\begin{array}{l} \text{4,75 V} \leq V_{\text{CC}} \leq 5.25 \text{ V}, \\ V_{\text{TxD}} = \text{"low"}, \\ \text{50 } \Omega < R_L < 65 \ \Omega \end{array}$	
7.1.38	CANH, CANL "dominant" output voltage difference $V_{\rm diff} = V_{\rm CANH} - V_{\rm CANL}$	V_{diff}	1.5	-	3.0	100 X	4,75 V ≤ $V_{\rm CC}$ ≤ 5.25 V, $V_{\rm TXD}$ = "low", 50 Ω < R_{I} < 65 Ω	
7.1.39		V_{SYM}	4.5	V.	5.5	V	$V_{\rm TxD} = 0 \text{ V}, V_{\rm CC} = 5 \text{ V},$ $50 \Omega < R_L < 65 \Omega$	



Table 6 Electrical Characteristics (cont'd)

4.5 V < $V_{\rm CC}$ < 5.5 V; $R_{\rm L}$ = 60 Ω ; -40 °C < $T_{\rm i}$ < +150 °C; all voltages with respect to ground; positive current flowing into the pin; unless otherwise specified.

Pos.	Parameter	Symbol	Limit	Values	To out !	Unit	Remarks
	LM MILLIONS C	OW.I	Min.	Тур.	Max.	CO_{M}	TV
7.1.40	CANL short-circuit current	I _{CANLsc}	40	80	100	mA	$V_{TXD} = 0 \; V, \; V_{CC} = 5 \; V, \; t < t_{TXD}$ $V_{CANLshort} = 18 \; V$
7.1.41	CANH short-circuit current	I_{CANHsc}	-100	-80	-40	mA	$V_{TXD} = 0 \; V, \; V_{CC} = 5 \; V, \; t < t_{TXD}$ $V_{CANHshort} = 0 \; V$
7.1.42	Leakage current CANH	$I_{CANH,lk}$	-5	0	5	μΑ	$ \begin{aligned} V_{\mathrm{CC}} &= 0 \text{ V}, \ V_{\mathrm{CANH}} = V_{\mathrm{CANL}}, \\ 0 \text{ V} &< V_{\mathrm{CANH}}, < 5 \text{ V} \end{aligned} $
7.1.43	Leakage current CANL	$I_{CANL,lk}$	-5	0	5	μА	$\begin{aligned} V_{\mathrm{CC}} &= 0 \text{ V}, \ V_{\mathrm{CANH}} = V_{\mathrm{CANL}}, \\ 0 \text{ V} &< V_{\mathrm{CANL}} < 5 \text{ V} \end{aligned}$
Dynar	nic CAN Transceiver Characte	ristics	OM.T	- 1	115	W.10	COMIT
7.1.44	Propagation delay TxD to RxD "low" ("recessive" to "dominant")	$t_{\sf d(L),TR}$	30	170	255	ns	$C_{\rm L}$ = 100 pF, $V_{\rm CC}$ = 5 V, $C_{\rm RxD}$ = 15 pF
7.1.45	Propagation delay TxD to RxD "high" ("dominant" to "recessive")	$t_{\sf d(H),TR}$	30	200	255	ns	$C_{\rm L}$ = 100 pF, $V_{\rm CC}$ = 5 V, $C_{\rm RxD}$ = 15 pF
7.1.46	Propagation delay TxD "low" to bus "dominant"	$t_{d(L),T}$	100X.C	90		ns	$^{1)}$ $C_{\rm L}$ = 100 pF, $V_{\rm CC}$ = 5 V, $C_{\rm RxD}$ = 15 pF
7.1.47	Propagation delay TxD "high" to bus "recessive"	$t_{d(H),T}$	N.1007	90	. IN	ns	$^{1)}$ $C_{\rm L}$ = 100 pF, $V_{\rm CC}$ = 5 V, $C_{\rm RxD}$ = 15 pF
7.1.48	Propagation delay bus "dominant" to RxD "low"	$t_{d(L),R}$	14.100	80	MITW	ns	$^{1)}$ $C_{\rm L}$ = 100 pF, $V_{\rm CC}$ = 5 V, $C_{\rm RxD}$ = 15 pF
7.1.49	Propagation delay bus "recessive" to RxD "high"	$t_{d(H),R}$	WW.	110		ns	$^{1)}$ $C_{\rm L}$ = 100 pF, $V_{\rm CC}$ = 5 V, $C_{\rm RxD}$ = 15 pF
7 1 50	Time for mode change	t_{Mode}	ALVI VA	Tony.	10	μS	1) WW 1004.

¹⁾ Not subject to production test, specified by design WWW.100Y.COM.



7.2 Diagrams

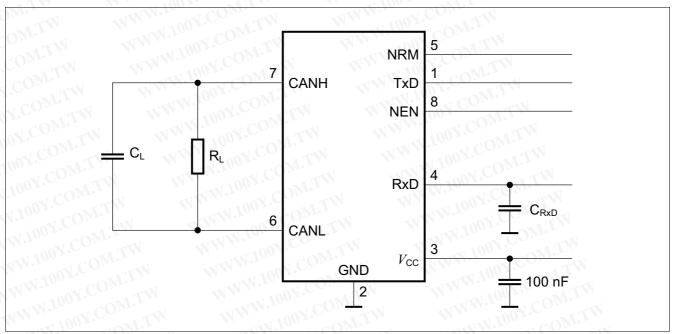


Figure 8 Simplified test circuit

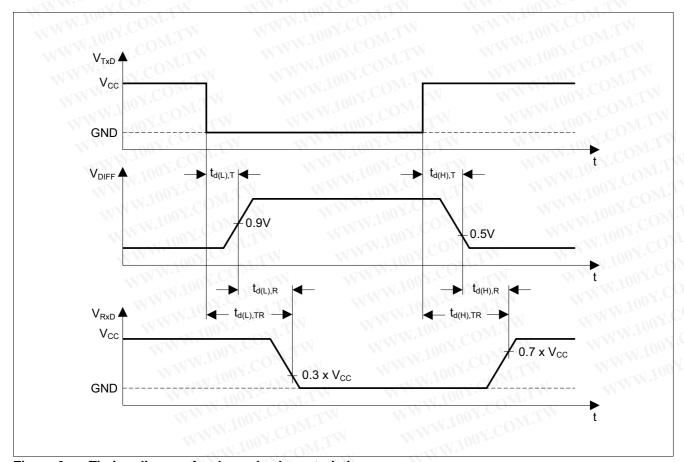


Figure 9 Timing diagram for dynamic characteristics



Application Information

OOY.COM.TW 8 **Application Information**

ESD Immunity According to IEC61000-4-2 8.1

Tests for ESD immunity according to IEC61000-4-2, "Gun test" (150 pF, 330 Ω), have been performed. The results and test conditions are available in a separate test report.

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ESD Immunity according to IEC61000-4-2 Table 7

and test conditions are available in a separate t	est report.						
Table 7 ESD Immunity according to IEC61000-4-2							
Test performed	Result	Unit	Remarks				
Electrostatic discharge voltage at CANH and CANL pins against GND	≥ +8	kV	¹⁾ Positive pulse				
Electrostatic discharge voltage at CANH and CANL pins against GND	≤ -8	kV	1)Negative pulse				

¹⁾ ESD susceptibility "ESD GUN" according to Gift / ICT paper: "EMC Evaluation of CAN Transceivers, version 03/02/ IEC WWW.100Y.COM TS 62228", section 4.3. (DIN EN 61000-4-2) WWW.100Y.COM.TW

WWW.100Y.COM.TW **Data Sheet** Rev. 1.1, 2013-07-22

Tested by external test house (IBEE Zwickau, EMC test report no.: 03-01-12). WWW.100Y.CON WWW.100Y.COM



Application Information

8.2 Application Example

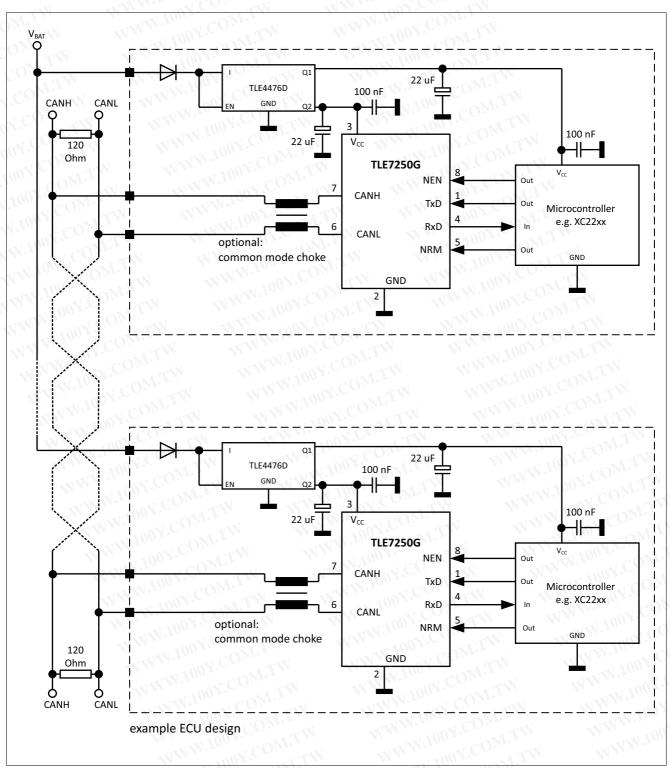


Figure 10 Simplified application for the TLE7250G

8.3 Further Application Information

- · Please contact us for information regarding the FMEA pin.
- For further information you may visit http://www.infineon.com/



Package Outlines

9 Package Outlines

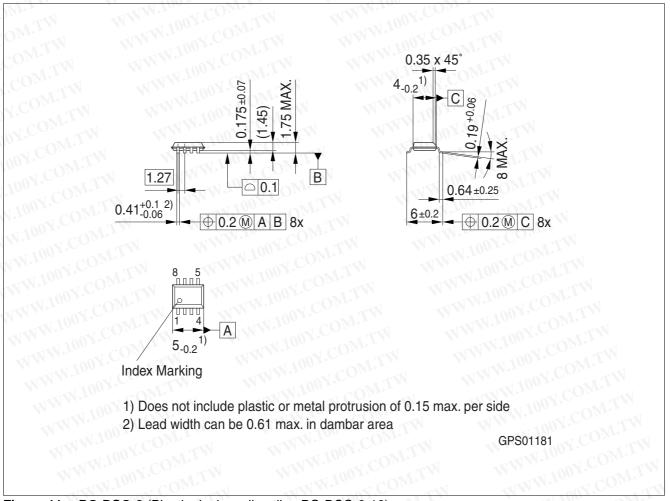


Figure 11 PG-DSO-8 (Plastic dual small outline PG-DSO-8-16)

Green Product (RoHS-compliant)

The device has been designed as a green product to meet the world-wide customer requirements for environment-friendly products and to be compliant with government regulations. Green products are RoHS-compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).



100Y.COM.TW 10 Revision History

Revision	Date	Changes
1.1 COM.TW COM.T	2013-07-22	 Update from Data Sheet Rev. 1.0: All pages: Revision and date updated. Page 3, Overview: Feature list updated ("Extended supply range at V_{CC}"). Page 13, Table 4, Parameter 6.2.1: Supply range updated (4.5 V < V_{CC} < 5.5V). Page 14, Table 6: Table header update (4.5 V < V_{CC} < 5.5V). Page 15, Table 6, Parameter 7.1.23: Remark removed "normal-operating mode". Page 15, Table 6, Parameter 7.1.24: Remark removed "normal-operating mode". Page 15, Table 6, Parameter 7.1.25: Remark removed "normal-operating mode". Page 15, Table 6, Parameter 7.1.26: Remark removed "normal-operating mode". Page 15, Table 6, Parameter 7.1.36: Remark added "4,75 V ≤ V_{CC} ≤ 5.25 V". Page 15, Table 6, Parameter 7.1.37: Remark added "4,75 V ≤ V_{CC} ≤ 5.25 V". Page 15, Table 6, Parameter 7.1.38: Remark added "4,75 V ≤ V_{CC} ≤ 5.25 V". Page 19, Figure 10: Picture updated.
	VW.100Y.CO	• Page 21:
	M. T. TOOK C.	Revision history updated.

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